

NONVOLATILE SEMICONDUCTOR MEMORY DEVICE
CAPABLE OF ACCURATELY AND QUICKLY
ADJUSTING STEP-UP VOLTAGE

5 BACKGROUND OF THE INVENTION

Field of the Invention

The present invention relates to a nonvolatile semiconductor memory device, and more particularly, to the adjustment of a step-up voltage thereof.

10 Description of the Related Art

In a nonvolatile semiconductor memory device such as a flash electrically erasable and programmable read only memory (EEPROM) device, a step-up voltage higher than an external power supply voltage is required for a write 15 operation and an erase operation. Usually, such a step-up voltage is internally generated by using a step-up circuit.

The lower the step-up voltage, the larger the number of defective write/erase operations. On the other hand, the higher the step-up voltage, the shorter the life time of the 20 device. Therefore, it is important to adjust the step-up voltage to a desired value. Note that this desire value is preferably a little higher than the minimum voltage by which a write or erase operation can be carried out.

In a prior art nonvolatile semiconductor device, in 25 order to decrease a writing operation time and improve the reliability, the step-up voltage is gradually changed during a write operation (see: JP-A-2000-113690).

In the above-described prior art nonvolatile semiconductor memory device, however, since it is not easy to 30 adjust the step-up voltage accurately and quickly, the device would be deemed to be defective and scrapped in spite of the fact that the device can be normally operated, which would decrease the manufacturing yield.

SUMMARY OF THE INVENTION

It is an object of the present invention to provide a nonvolatile semiconductor memory device capable of accurately and quickly adjusting a step-up voltage.

According to the present invention, in a nonvolatile semiconductor memory device including a nonvolatile cell circuit, a step-up circuit receives a clock signal to generate a step-up voltage for the nonvolatile cell circuit. A voltage divider divides the step-up voltage to generate a plurality of voltages. A selector selects one of the voltages. A reference voltage generating circuit generates a reference voltage. A first comparator compares the selected one of the voltages with the reference voltage. A gate circuit supplies the clock signal to the step-up circuit in accordance with an output signal of the first comparator so that the selected one of the voltages is brought close to the reference voltage. Also, a second comparator compares the step up voltage with an externally-provided expected value. A counting signal generating circuit generates a counting signal in accordance with an output signal of the first comparator. A counter changes a value thereof by receiving the counting signal. Thus, the selector selects the one of the voltages in accordance with the value of the counter, so that the step-up voltage is brought close to the expected value.

BRIEF DESCRIPTION OF THE DRAWINGS

The present invention will be more clearly understood from the description set forth below, with reference to the accompanying drawings, wherein:

Fig. 1 is a circuit diagram illustrating a first embodiment of the nonvolatile semiconductor memory device according to the present invention;

Figs. 2 and 3 are timing diagrams for explaining the nonvolatile semiconductor memory device of Fig. 1;

Fig. 4 is a circuit diagram illustrating a second embodiment of the nonvolatile semiconductor memory device 5 according to the present invention; and

Figs. 5 and 6 are timing diagrams for explaining the nonvolatile semiconductor memory device of Fig. 4.

DESCRIPTION OF THE PREFERRED EMBODIMENTS

10 In Fig. 1, which illustrates a first embodiment of the nonvolatile semiconductor memory device according to the present invention, a nonvolatile semiconductor memory device 100 is connected to a tester 200.

15 In Fig. 1, a step-up circuit 11 including a charge pump circuit generates a step-up voltage V_{pp} and transmits it to a nonvolatile cell circuit 12, particularly, its decoder portion 12a.

20 The step-up voltage V_{pp} of the step-up circuit 11 is determined by receiving a clock signal CLK via a NOR circuit 13. In this case, the step-up voltage V_{pp} is controlled by a first feedback circuit FB1 connected between the step-up circuit 11 and the NOR circuit 13, so that the output voltage V_i of the selector 15 is brought close to the reference voltage V_{ref} of the reference voltage generating circuit 16. That is,

25
$$V_i = V_{ref}$$

The first feedback circuit FB1 will next be explained in detail.

30 The first feedback circuit FB1 is formed by a voltage divider 14, a selector 15, a reference voltage generating circuit 16 and a comparator 17.

The voltage divider 14 is constructed by a ladder of resistors between the output of the step-up circuit 11 and the ground terminal GND. For example, eight resistors whose

resistance values are defined by R_0, R_1, \dots, R_7 is provided. In this case, voltages V_0, V_1, \dots, V_7 can be defined by

$$V_0 = V_{pp}$$

$$V_1 = (R_1 + R_2 + \dots + R_7) V_{pp} / R$$

5 $V_2 = (R_2 + R_3 + \dots + R_7) V_{pp} / R$
 ...

$$V_7 = R_7 \cdot V_{pp} / R$$

$$\text{where } R = R_0 + R_1 + \dots + R_7$$

The selector 15 is constructed by eight switches 150, 10 151, ..., 157. Therefore, when the switches 150, 151, ..., 157, respectively, is turned ON, the step-up voltage V_{pp} is brought close to:

$$V_{pp} = V_0 = V_{ref}$$

$$V_{pp} = V_1 = R \cdot V_{ref} / (R_1 + R_2 + \dots + R_7)$$

15 $V_{pp} = V_2 = R \cdot V_{ref} / (R_2 + R_3 + \dots + R_7)$
 ...

$$V_{pp} = V_7 = R \cdot V_{ref} / R_7$$

For example, if the values of the resistors R_0, R_1, \dots, R_7 are the same as each other, the step-up voltage V_{pp} is 20 brought close to:

$$V_{pp} = V_0 = 1.5V$$

$$V_{pp} = V_1 = 1.71V$$

$$V_{pp} = V_2 = 2.0V$$

...

25 $V_{pp} = V_7 = 12V$

The selector 15 is controlled by a second feedback circuit FB2 connected between the output of the step-up circuit 11 and the selector 15, so that the step-up voltage V_{pp} is brought close to an expected voltage V_{ppc} from the tester 30 200. That is

$$V_{pp} = V_{ppc}$$

The second feedback circuit FB2 will next be explained in detail.

The second feedback circuit FB2 is formed by a comparator 18, a count-up signal generating circuit 19 and an up counter 20.

5 The comparator 18 compares the step-up voltage V_{pp} with the expected voltage V_{ppe} to generate a comparison signal S_1 . Note that the comparison signal S_1 is also supplied to the tester 200.

10 The count-up signal generating circuit 19 is constructed by a sampling signal generating circuit 191 for generating a sampling signal S_2 , an AND circuit 192 for passing the sampling signal in accordance with the comparison signal S_1 , and a delay circuit 193 for delaying the output signal of the AND circuit 192 to generate a count-up signal S_3 . Note that the sampling signal generating circuit 191 is constructed by 15 a counter 1911 for counting pulses of the clock signal CLK to generate a timing signal having a predetermined time period and an AND circuit 1912 for passing the timing signal in accordance with an enable signal EN from the tester 200.

20 The value N of the up counter 20 is cleared by a clear signal CL from the tester 200, and is counted up by receiving the count-up signal S_3 from the count-up signal generating circuit 19. When the adjustment of the value N of the up counter 20 is completed, the value N is stored as an adjusted value N_a in an adjustment area 12b of the nonvolatile cell circuit 25 12.

30 Also, after the adjustment of the value N of the up counter 20, when the tester 200 is separated from the nonvolatile semiconductor device 100, the adjusted value N_a of the adjustment area 12b of the nonvolatile cell circuit 12 is set in the counter 20 by a power-on signal PON.

Further, the tester 200 supplies an address signal ADD, a write signal W and the expected voltage V_{ppe} to the nonvolatile cell circuit 12 to operate the nonvolatile cell

circuit 12 even in an adjustment mode of the value N of the up counter 20.

The adjustment operation of the nonvolatile semiconductor device 100 of Fig. 1 by the tester 200 will be 5 explained next with reference to Fig. 2.

First, at time t_0 , the tester 200 generates a clear signal CL. As a result, the value N of the counter 20 is cleared, i.e.,

$$N = 0$$

10 Also, the tester 200 generates an enable signal EN, so that the sampling signal generating circuit 191 is enabled.

In this state ($N = 0$), the step-up voltage V_{pp} is brought close to V_0 by the first feedback circuit FB1; however, the step-up voltage V_{pp} is still below the expected value V_{ppe} , 15 so that the comparison signal S_1 remains high ("1").

Next, at time t_1 , a sampling signal S_2 is generated from the sampling signal generating circuit 191, and subsequently, a count-up signal S_3 is generated from the count-up signal generating circuit 19. As a result, the value 20 N of the up counter 20 is counted up by + 1, so that

$$N = 1$$

In this state ($N = 1$), the step-up voltage V_{pp} is brought close to V_1 by the first feedback circuit FB1; however, the step-up voltage V_{pp} is still below the expected value V_{ppe} , 25 so that the comparison signal S_1 remains high ("1").

Next, at time t_2 , a sampling signal S_2 is generated from the sampling signal generating circuit 191, and subsequently, a count-up signal S_3 is generated from the count-up signal generating circuit 19. As a result, the value 30 N of the up counter 20 is counted up by + 1, so that

$$N = 2$$

In this state ($N = 2$), the step-up voltage V_{pp} is brought close to V_2 by the first feedback circuit FB1; however,

the step-up voltage V_{pp} is still below the expected value V_{pp_e} , so that the comparison signal S_1 remains high ("1").

Next, at time t_3 , a sampling signal S_2 is generated from the sampling signal generating circuit 191, and subsequently, a count-up signal S_3 is generated from the count-up signal generating circuit 19. As a result, the value N of the up counter 20 is counted up by + 1, so that

$$N = 3$$

In this state ($N = 3$), the step-up voltage V_{pp} is brought close to V_3 by the first feedback circuit FB1, so that the step-up voltage V_{pp} exceeds the expected value V_{pp_e} . Thus, the comparison signal S_1 is switched from high ("1") to low ("0"), so that the step-up voltage V_{pp} is brought close to the expected voltage V_{pp_e} by the second feedback circuit FB2.

As a result, upon receipt of the change of the comparison signal S_1 , the tester 200 stops the generation of the enable signal EN, so that the sampling signal S_2 and the count-up signal S_3 are no longer generated. Thus, the adjustment of the value N of the up counter 20 is completed, i.e., the value N of the up counter 20 is fixed at "3".

Finally, the tester 200 supplies a write signal W and an address signal ADD indicating the adjustment area 12b, so that the value "3" of the up counter 20 is stored in the adjustment area of the nonvolatile cell circuit 12.

The post-adjustment operation of the nonvolatile semiconductor memory device of Fig. 1 will be explained next with reference to Fig. 3. Here, assume that the value "3" is stored in the adjustment area 12b of the nonvolatile cell circuit 12.

First, a power-on signal PON is generated from a control circuit (not shown) which also generates a read signal R and an address signal ADD indicating the adjustment area 12b. Therefore, the value "3" is transferred from the adjustment

area 12b of the nonvolatile cell circuit 12 to the up counter 20. As a result, the step-up voltage V_{pp} is brought close to V_3 by the first feedback circuit. In this case, since the enable signal EN remains low (= "0") due to the presence of a resistor 191a, no sampling signal S_2 and no count-up signal S_3 are generated. Thus, the value "3" of the up counter 20 is unchanged.

In Fig. 1, a resistor 18a having a relatively large resistance is connected to a terminal to which the expected value V_{pp} is applied. As a result, in the post-adjustment 10 operation, since the expected value V_{pp} is 0V, the generation of count-up signals can be further suppressed, which more surely prevent a change in the value of the counter 20.

In Fig. 4, which illustrates a second embodiment of 15 the nonvolatile semiconductor memory device according to the present invention, a nonvolatile semiconductor memory device 100' is connected to a tester 200'.

In the nonvolatile semiconductor memory device 100', the comparator 18 of Fig. 1 is replaced by a comparator 18' 20 whose output polarity is opposite to that of the comparator 18 of Fig. 1. Also, the up counter 20 of Fig. 1 is replaced by a down counter 20', and the tester 200' generates a preset signal PS for the down counter 20' instead of the clear signal CL of Fig. 1. Note that the count-up signal generating circuit 25 19 of Fig. 1 is replaced by a count-down signal generating circuit 19'; however, the count-down signal generating circuit 19' has the same configuration as the count-up signal generating circuit 19 of Fig. 1.

The value N of the down counter 20' is preset by a 30 preset signal PS from the tester 200' to a preset value such as "7", and is counted down by receiving the count-down signal S_3' from the count-down signal generating circuit 19'. When the adjustment of the value N of the down counter 20' is completed,

the value N is stored as an adjusted value N_a in the adjustment area 12b of the nonvolatile cell circuit 12.

Also, after the adjustment of the value N of the down counter 20', when the tester 200' is separated from the nonvolatile semiconductor device 100', the adjusted value N_a of the adjustment area 12b of the nonvolatile cell circuit 12 is set in the down counter 20' by a power-on signal PON.

Further, the tester 200' supplies an address signal ADD, a write signal W and the expected voltage V_{pp_e} to the nonvolatile cell circuit 12 to operate the nonvolatile cell circuit 12 even in an adjustment mode of the value N of the down counter 20'.

The adjustment operation of the nonvolatile semiconductor device 100' of Fig. 4 by the tester 200' will be explained next with reference to Fig. 5.

First, at time t_0 , the tester 200' generates a preset signal PS. As a result, the value N of the counter 20' is preset, i.e.,

$$N = 7$$

Also, the tester 200' generates an enable signal EN, so that the sampling signal generating circuit 191 is enabled.

In this state ($N = 7$), the step-up voltage V_{pp} is brought close to V_7 by the first feedback circuit FB1; however, the step-up voltage V_{pp} is still higher than the expected value V_{pp_e} , so that the comparison signal S_1 remains high (= "1").

Next, at time t_1 , a sampling signal S_2 is generated from the sampling signal generating circuit 191, and subsequently, a count-down signal S_3' is generated from the count-down signal generating circuit 19'. As a result, the value N of the down counter 20' is counted down by 1, so that

$$N = 6$$

In this state ($N = 6$), the step-up voltage V_{pp} is brought close to V_6 by the first feedback circuit FB1; however,

the step-up voltage V_{pp} is still higher than the expected value V_{ppe} , so that the comparison signal S_1 remains high ("1").

Next, at time t_2 , a sampling signal S_2 is generated from the sampling signal generating circuit 191, and

5 subsequently, a count-down signal S_3' is generated from the count-down signal generating circuit 19'. As a result, the value N of the down counter 20' is counted down by 1, so that

$$N = 5$$

In this state ($N = 5$), the step-up voltage V_{pp} is
10 brought close to V_5 by the first feedback circuit FB1; however, the step-up voltage V_{pp} is still higher than the expected value V_{ppe} , so that the comparison signal S_1 remains high ("1").

Next, at time t_3 , a sampling signal S_2 is generated from the sampling signal generating circuit 191, and

15 subsequently, a count-down signal S_3' is generated from the count-down signal generating circuit 19'. As a result, the value N of the down counter 20' is counted down by 1, so that

$$N = 4$$

In this state ($N = 4$), the step-up voltage V_{pp} is
20 brought close to V_4 by the first feedback circuit FB1, so that the step-up voltage V_{pp} is below expected value V_{ppe} . Thus, the comparison signal S_1 is switched from high ("1") to low ("0"), so that the step-up voltage V_{pp} is close to the expected voltage V_{ppe} .

25 As a result, upon receipt of the change of the comparison signal S_1 , the tester 200' stops the generation of the enable signal EN, so that the sampling signal S_2 and the count-up signal S_3 are no longer generated. Thus, the adjustment of the value N of the down counter 20' is completed,
30 i.e., the value N of the down counter 20' is fixed at "4".

Finally, the tester 200' supplies a write signal W and an address signal ADD indicating the adjustment area 12b, so that the value "4" of the down counter 20' is stored in the

adjustment area of the nonvolatile cell circuit 12.

The post-adjustment operation of the nonvolatile semiconductor memory device of Fig. 3 will be explained next with reference to Fig. 5. Here, assume that the value "3" is stored in the adjustment area 12b of the nonvolatile cell circuit 12.

First, a power-on signal PON is generated from a control circuit (not shown) which also generates a read signal R and an address signal ADD indicating the adjustment area 12b.

10 As a result, the value "4" is set from the adjustment area 12b of the nonvolatile cell circuit 12 to the down counter 20'. As a result, the step-up voltage V_{pp} is brought close to V_4 by the first feedback circuit. In this case, since the enable signal EN remains low (= "0") due to the presence of a resistor 191a, no sampling signal S_2 and no count-down signal S_3' are generated. Thus, the value "4" of the down counter 20' is unchanged.

As explained hereinabove, according to the present invention, since a step-up voltage can be adjusted accurately 20 and quickly, nonvolatile semiconductor memory devices would not be deemed to be defective and scrapped in spite of the fact that the devices can be normally operated, so that the manufacturing yield would be increased.